# M1MA141WAT1G, M1MA142WAT1G, SM1MA142WAT1G

# **Common Anode Silicon Dual Switching Diode**

This Common Anode Silicon Epitaxial Planar Dual Diode is designed for use in ultra high speed switching applications. This device is housed in the SC-70 package which is designed for low power surface mount applications.

#### **Features**

- Fast  $t_{rr}$ , < 10 ns
- Low  $C_D$ , < 15 pF
- AEC-Q101 Qualified and PPAP Capable
- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant\*

### **MAXIMUM RATINGS** $(T_A = 25^{\circ}C)$

Rating	Symbol	Value	Unit
Reverse Voltage M1MA141WAT1G M1MA142WAT1G, SM1MA142WAT1G	V <sub>R</sub>	40 80	Vdc
Peak Reverse Voltage M1MA141WAT1G M1MA142WAT1G, SM1MA142WAT1G	V <sub>RM</sub>	40 80	Vdc
Forward Current Single Dual	I <sub>F</sub>	100 150	mAdc
Peak Forward Current Single Dual	I <sub>FM</sub>	225 340	mAdc
Peak Forward Surge Current M1MA141WAT1G M1MA142WAT1G, SM1MA142WAT1G	I <sub>FSM</sub> (Note 1)	500 750	mAdc

# THERMAL CHARACTERISTICS

Rating	Symbol	Max	Unit
Power Dissipation	$P_{D}$	150	mW
Junction Temperature	$T_{J}$	150	°C
Storage Temperature	T <sub>stg</sub>	<b>−55</b> ~ <b>+150</b>	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

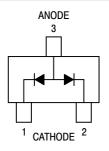


# ON Semiconductor®

http://onsemi.com



SC-70 (SOT-323) CASE 419 STYLE 4



#### **MARKING DIAGRAM**



Mx = Device Code

= N for 141

O for 142 M = Date Code\*

= Pb-Free Package

(Note: Microdot may be in either location)

# ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
M1MA141WAT1G	SC-70 (Pb-Free)	3,000 / Tape & Reel
M1MA142WAT1G	SC-70 (Pb-Free)	3,000 / Tape & Reel
SM1MA142WAT1G	SC-70 (Pb-Free)	3,000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

<sup>1.</sup> t = 1 sec

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

<sup>\*</sup>Date Code orientation may vary depending upon manufacturing location.

# ${\tt M1MA141WAT1G,\,M1MA142WAT1G,\,SM1MA142WAT1G}$

# **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C)

Characteristic	Condition	Symbol	Min	Max	Unit
Reverse Voltage Leakage Current M1MA141WAT1G M1MA142WAT1G, SM1MA142WAT1G	V <sub>R</sub> = 35 V V <sub>R</sub> = 75 V	I <sub>R</sub>	- -	0.1 0.1	μAdc
Forward Voltage	I <sub>F</sub> = 100 mA	V <sub>F</sub>	-	1.2	Vdc
Reverse Breakdown Voltage M1MA141WAT1G, M1MA142WAT1G, SM1MA142WAT1G	I <sub>R</sub> = 100 μA	V <sub>R</sub>	40 80	- -	Vdc
Diode Capacitance	V <sub>R</sub> = 0, f = 1.0 MHz	C <sub>D</sub>	-	15	pF
Reverse Recovery Time (Figure 1)	$I_F = 10 \text{ mA}, V_R = 6.0 \text{ V},$ $R_L = 100 \ \Omega, I_{rr} = 0.1 \ I_R$	t <sub>rr</sub> (Note 2)	-	10	ns

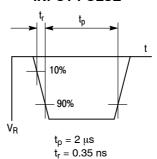
<sup>2.</sup> t<sub>rr</sub> Test Circuit

# M1MA141WAT1G, M1MA142WAT1G, SM1MA142WAT1G

# RECOVERY TIME EQUIVALENT TEST CIRCUIT

# A RL

# **INPUT PULSE**



# **OUTPUT PULSE**

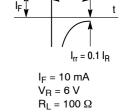


Figure 1. Recovery Time Equivalent Test Circuit

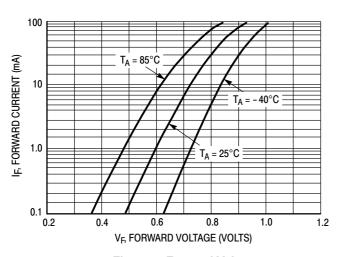


Figure 2. Forward Voltage

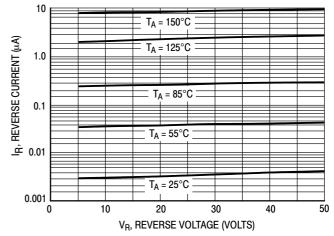


Figure 3. Reverse Current

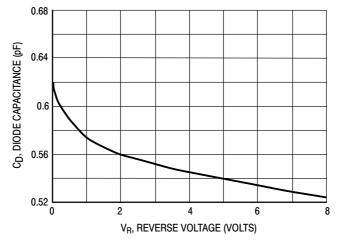


Figure 4. Diode Capacitance





SC-70 (SOT-323) **CASE 419** ISSUE R

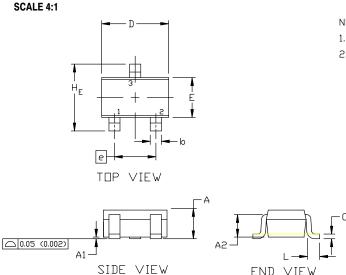
END VIEW

**DATE 11 OCT 2022** 

#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH

	MILLIMETERS				INCHES		
DIM	MIN.	N□M.	MAX.	MIN.	N□M.	MAX.	
Α	0.80	0.90	1.00	0.032	0.035	0.040	
A1	0.00	0.05	0.10	0.000	0.002	0.004	
A2		0.70 REF	-		0.028 BSC		
b	0.30	0.35	0.40	0.012	0.014	0.016	
С	0.10	0.18	0.25	0.004	0.007	0.010	
D	1.80	2.00	2.20	0.071	0.080	0.087	
E	1.15	1.24	1.35	0.045	0.049	0.053	
е	1.20	1.30	1.40	0.047	0.051	0.055	
e1	0.65 BSC				0.026 BS	C	
L	0.20	0.38	0.56	0.008	0.015	0.022	
HE	2.00	2.10	2.40	0.079	0.083	0.095	



# **GENERIC MARKING DIAGRAM**

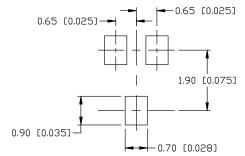


= Specific Device Code XX

Μ = Date Code

= Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.



For additional information on our Pb-Free strategy and soldering details, please download the ID Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

SOLDERING FOOTPRINT

STYLE 1: CANCELLED	STYLE 2: PIN 1. ANODE 2. N.C. 3. CATHODE	STYLE 3: PIN 1. BASE 2. EMITTER 3. COLLECTOR	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. ANODE	STYLE 5: PIN 1. ANODE 2. ANODE 3. CATHODE	
STYLE 6: PIN 1. EMITTER	STYLE 7: PIN 1. BASE	STYLE 8: PIN 1. GATE	STYLE 9: PIN 1. ANODE	STYLE 10: PIN 1. CATHODE	STYLE 11: PIN 1. CATHODE
2. BASE	2. EMITTER	2. SOURCE	2. CATHODE	2. ANODE	2. CATHODE
<ol><li>COLLECTOR</li></ol>	<ol><li>COLLECTOR</li></ol>	3. DRAIN	<ol><li>CATHODE-ANODE</li></ol>	3. ANODE-CATHODE	<ol><li>CATHODE</li></ol>

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